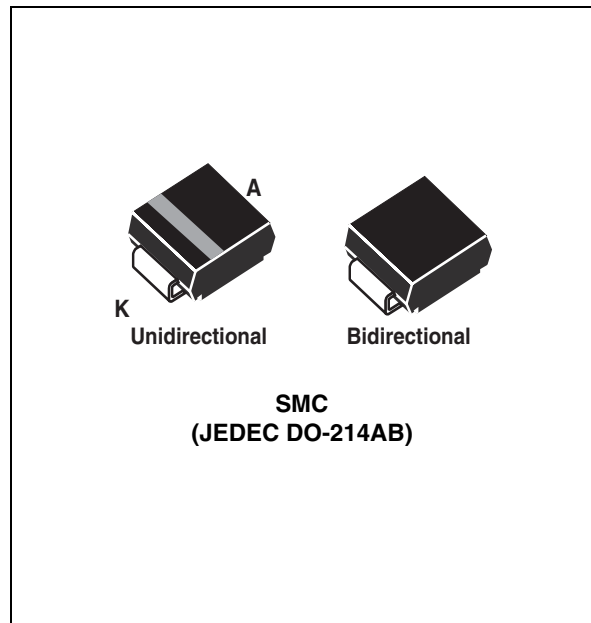


Features

- Peak pulse power:
 - 1500 W (10/1000 μ s)
 - 10 kW (8/20 μ s)
- Breakdown voltage range: from 6.8 V to 220 V
- Unidirectional and bidirectional types
- Low leakage current:
 - 0.2 μ A at 25 °C
 - 1 μ A at 85 °C
- Operating $T_{j\max}$: 150 °C
- High power capability at $T_{j\max}$:
 - 1250 W (10/1000 μ s)
- JEDEC registered package outline

Complies with the following standards

- IEC 61000-4-2 level 4
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-5
 - See [Table 3](#) for surge level
- MIL STD 883G, method 3015-7: class 3B
 - 25 kV HBM (human body model)
- UL 497B file number: QVGQ2.E136224
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint



Description

The SM15T Transil series has been designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2, and MIL STD 883, method 3015, and electrical over stress according to IEC 61000-4-4 and 5. These devices are more generally used against surges below 1500 W (10/1000 μ s).

Planar technology makes these devices suitable for high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

SM15T are packaged in SMC (SMC footprint in accordance with IPC 7531 standard).

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

| Symbol | Parameter | Value | Unit |
|-----------|---|---|--------------------|
| P_{PP} | Peak pulse power dissipation ⁽¹⁾ | $T_{j \text{ initial}} = T_{amb}$ 1500 | W |
| T_{stg} | Storage temperature range | -65 to + 150 | $^{\circ}\text{C}$ |
| T_j | Operating junction temperature range | -55 to + 150 | $^{\circ}\text{C}$ |
| T_L | Maximum lead temperature for soldering during 10 s. | 260 | $^{\circ}\text{C}$ |

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal parameter

| Symbol | Parameter | Value | Unit |
|---------------|--|-------|----------------------|
| $R_{th(j-l)}$ | Junction to leads | 15 | $^{\circ}\text{C/W}$ |
| $R_{th(j-a)}$ | Junction to ambient on printed circuit on recommended pad layout | 90 | $^{\circ}\text{C/W}$ |

Figure 1. Electrical characteristics - definitions

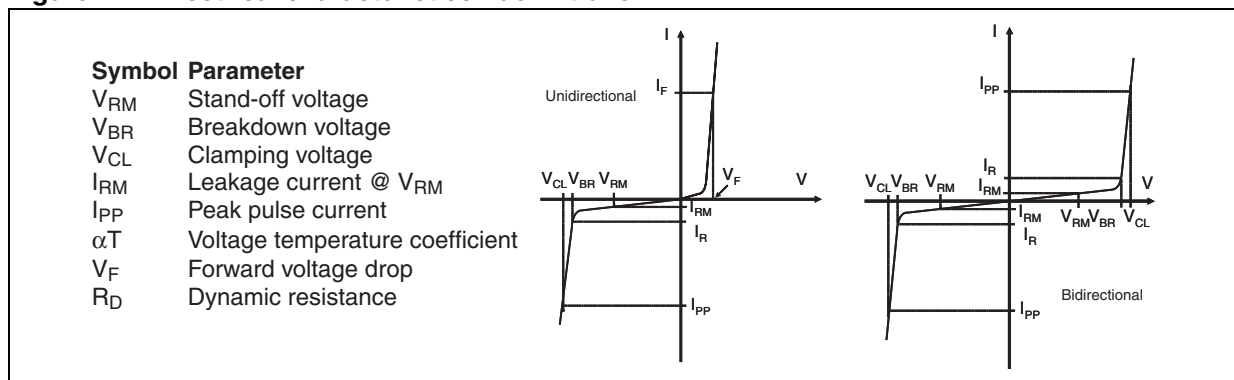


Figure 2. Pulse definition for electrical characteristics

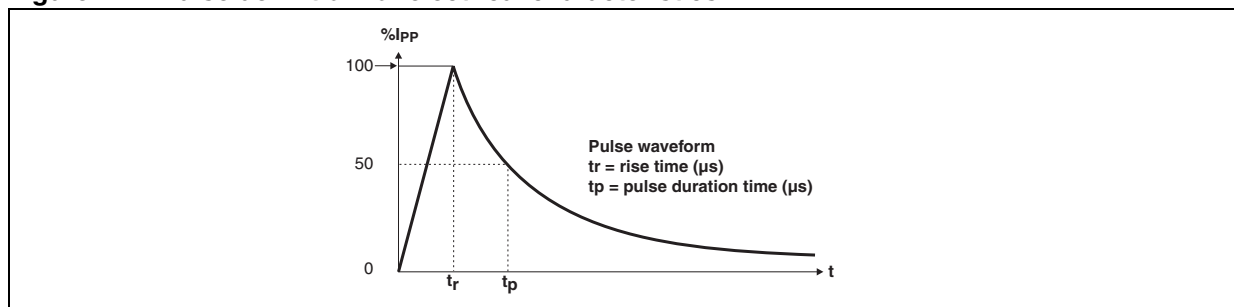


Table 3. Electrical characteristics, parameter values ($T_{amb} = 25\text{ °C}$)

| Order code | $I_{RM} \text{ max}@V_{RM}$ | | $V_{BR} @I_R^{(1)}$ | | | | $V_{CL} @I_{PP}$ 10/1000 μs | | R_D 10/1000 μs | $V_{CL} @I_{PP}$ 8/20 μs | | R_D 8/20 μs | $\alpha T^{(2)}$ | |
|--------------|-----------------------------|-------|---------------------|------|-----|------|---|------------------|-----------------------------------|--|------------------|--------------------------------|------------------|------|
| | 25 °C | 85 °C | min | typ | max | max | | | max | | | max | | |
| | μA | | V | V | | mA | V ⁽³⁾ | A ⁽⁴⁾ | Ω | V ⁽³⁾ | A ⁽⁴⁾ | Ω | 10-4/ °C | |
| SM15T6V8A/CA | 500 | 2000 | 5.8 | 6.45 | 6.8 | 7.14 | 10 | 10.5 | 143 | 0.023 | 13.4 | 746 | 0.008 | 5.7 |
| SM15T7V5A/CA | 250 | 1000 | 6.4 | 7.13 | 7.5 | 7.88 | 10 | 11.3 | 132 | 0.026 | 14.5 | 690 | 0.010 | 6.1 |
| SM15T10A/CA | 10 | 50 | 8.55 | 9.5 | 10 | 10.5 | 1 | 14.5 | 103 | 0.039 | 18.6 | 538 | 0.015 | 7.3 |
| SM15T12A/CA | 0.2 | 1 | 10.2 | 11.4 | 12 | 12.6 | 1 | 16.7 | 90 | 0.046 | 21.7 | 461 | 0.020 | 7.8 |
| SM15T15A/CA | 0.2 | 1 | 12.8 | 14.3 | 15 | 15.8 | 1 | 21.2 | 71 | 0.076 | 27.2 | 368 | 0.031 | 8.4 |
| SM15T18A/CA | 0.2 | 1 | 15.3 | 17.1 | 18 | 18.9 | 1 | 25.2 | 59.5 | 0.106 | 32.5 | 308 | 0.044 | 8.8 |
| SM15T22A/CA | 0.2 | 1 | 18.8 | 20.9 | 22 | 23.1 | 1 | 30.6 | 49 | 0.153 | 39.3 | 254 | 0.064 | 9.2 |
| SM15T24A/CA | 0.2 | 1 | 20.5 | 22.8 | 24 | 25.2 | 1 | 33.2 | 45 | 0.178 | 42.8 | 234 | 0.075 | 9.4 |
| SM15T27A/CA | 0.2 | 1 | 23.1 | 25.7 | 27 | 28.4 | 1 | 37.5 | 40 | 0.228 | 48.3 | 207 | 0.096 | 9.6 |
| SM15T30A/CA | 0.2 | 1 | 25.6 | 28.5 | 30 | 31.5 | 1 | 41.5 | 36 | 0.278 | 53.5 | 187 | 0.12 | 9.7 |
| SM15T33A/CA | 0.2 | 1 | 28.2 | 31.4 | 33 | 34.7 | 1 | 45.7 | 33 | 0.333 | 59.0 | 169 | 0.14 | 9.8 |
| SM15T36A/CA | 0.2 | 1 | 30.8 | 34.2 | 36 | 37.8 | 1 | 49.9 | 30 | 0.403 | 64.3 | 156 | 0.17 | 9.9 |
| SM15T39A/CA | 0.2 | 1 | 33.3 | 37.1 | 39 | 41.0 | 1 | 53.9 | 28 | 0.461 | 69.7 | 143 | 0.20 | 10.0 |
| SM15T68A/CA | 0.2 | 1 | 58.1 | 64.6 | 68 | 71.4 | 1 | 92 | 16.3 | 1.26 | 121 | 83 | 0.60 | 10.4 |
| SM15T75A/CA | 0.2 | 1 | 64.1 | 71.3 | 75 | 78.8 | 1 | 103 | 14.6 | 1.66 | 134 | 75 | 0.74 | 10.5 |
| SM15T100A/CA | 0.2 | 1 | 85.5 | 95.0 | 100 | 105 | 1 | 137 | 11 | 2.91 | 178 | 56 | 1.30 | 10.6 |
| SM15T150A/CA | 0.2 | 1 | 128 | 143 | 150 | 158 | 1 | 207 | 7.2 | 6.81 | 265 | 38 | 2.82 | 10.8 |
| SM15T200A/CA | 0.2 | 1 | 171 | 190 | 200 | 210 | 1 | 274 | 5.5 | 11.6 | 353 | 28 | 5.11 | 10.8 |
| SM15T220A/CA | 0.2 | 1 | 188 | 209 | 220 | 231 | 1 | 328 | 4.6 | 21.1 | 388 | 26 | 6.04 | 10.8 |

1. Pulse test : $t_p < 50\text{ ms}$

2. To calculate V_{BR} versus junction temperature, use the following formula: $V_{BR} @ T_J = V_{BR} @ 25\text{ °C} \times (1 + \alpha T \times (T_J - 25))$.

3. To calculate maximum clamping voltage at other surge level, use the following formula: $V_{CL} = R_D \times I_{PP} + V_{BRmax}$.

4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak pulse power dissipation versus initial junction temperature (printed circuit board)



Figure 4. Peak pulse power versus exponential pulse duration

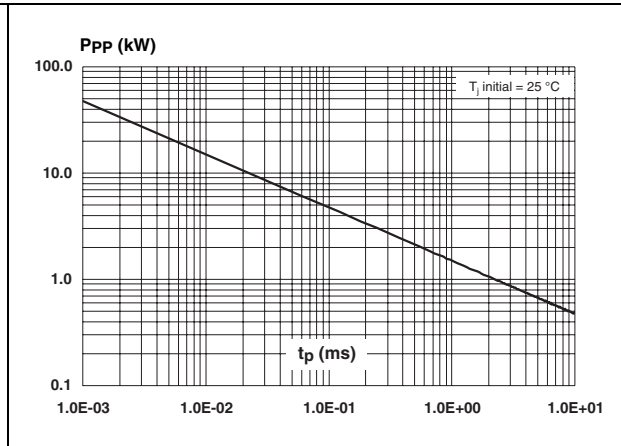


Figure 5. Clamping voltage versus peak pulse current (maximum values)

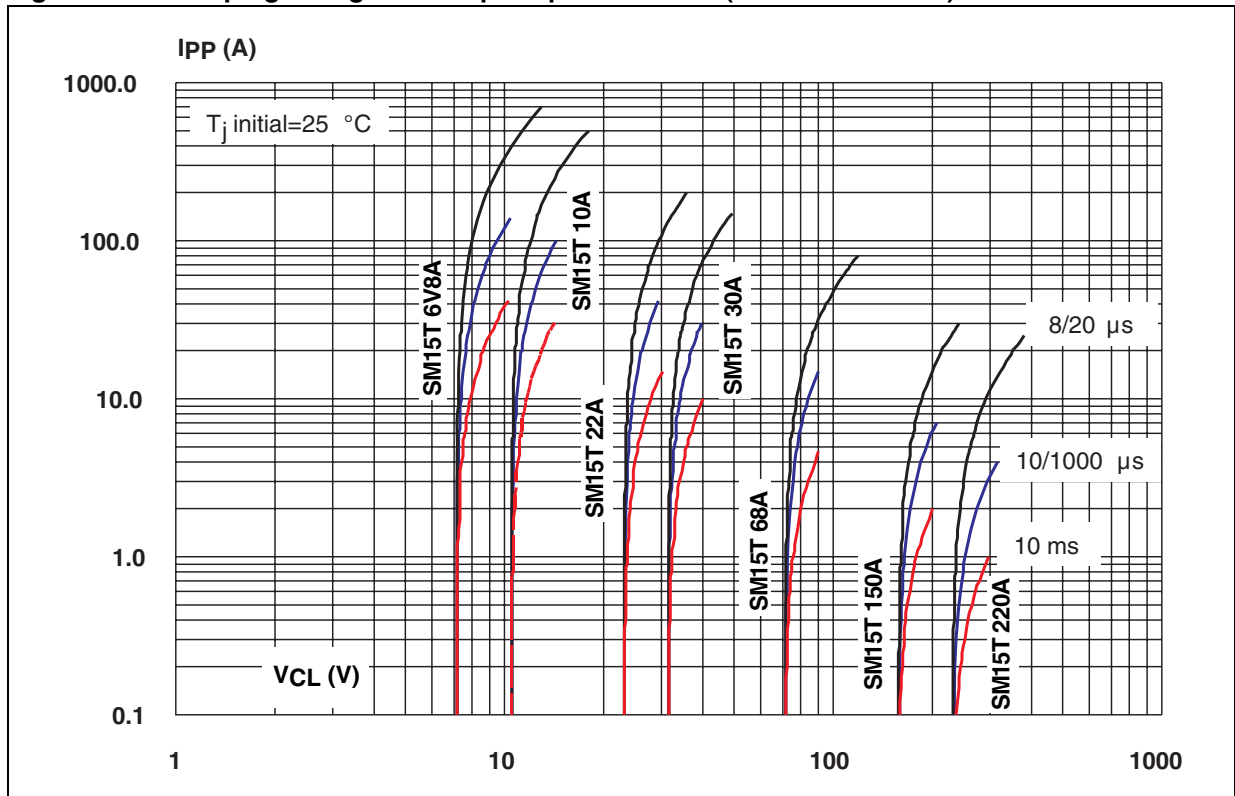


Figure 6. Capacitance versus reverse applied voltage (typical values, SM15TxxA)

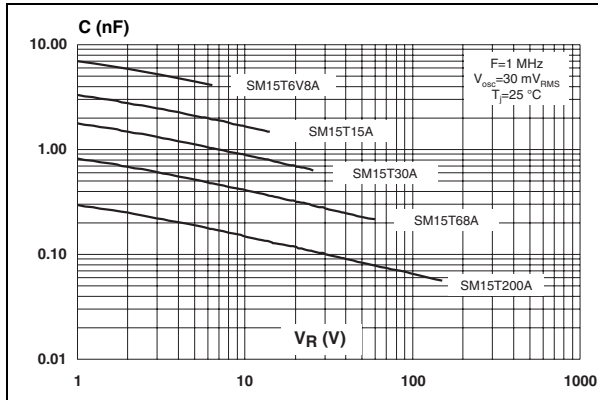


Figure 7. Capacitance versus reverse applied voltage (typical values, SM15TxxCA)

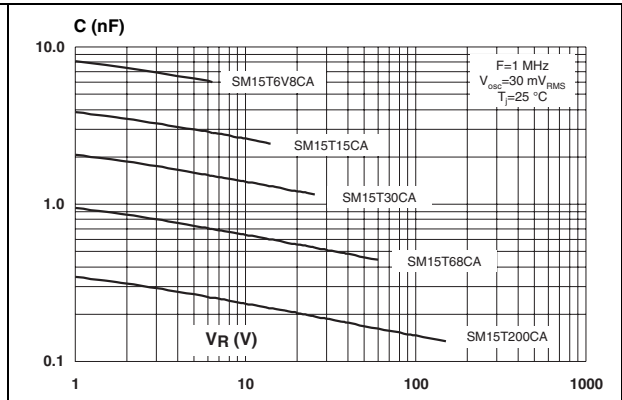


Figure 8. Peak forward voltage drop versus forward current (typical values)

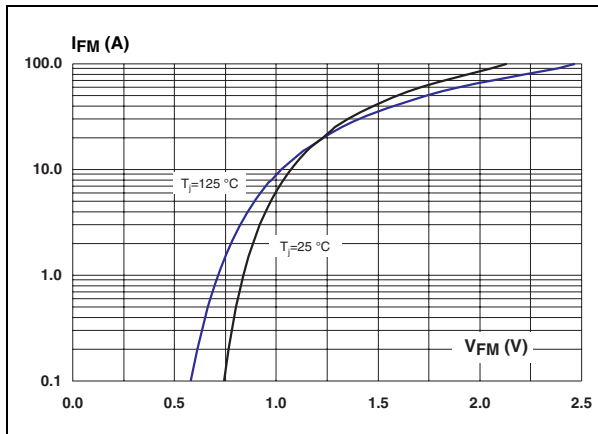


Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration

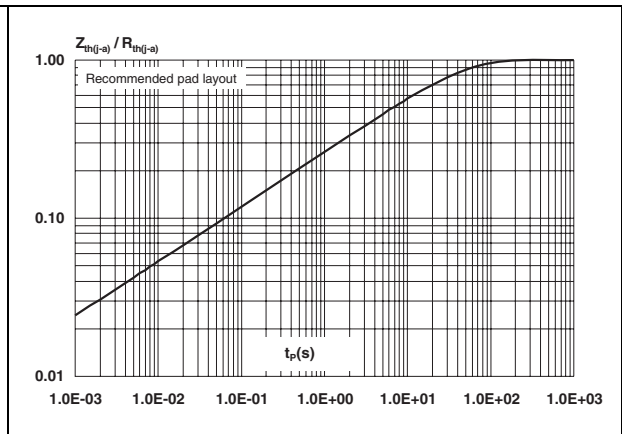


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead

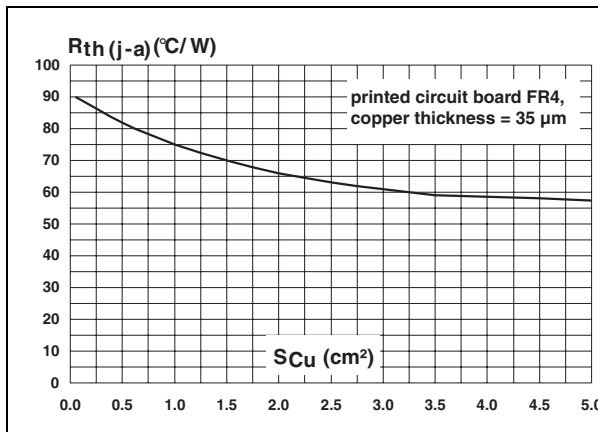
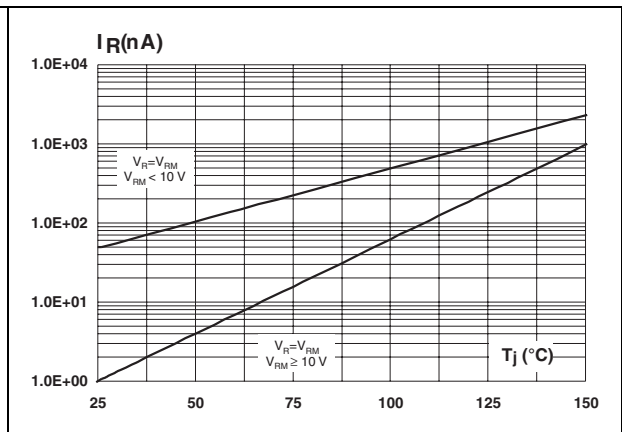


Figure 11. Leakage current versus junction temperature (typical values)



2 Ordering information scheme

Figure 12. Ordering information scheme



3 Package information

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL 94, V0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMC dimensions

| Ref. | Dimensions | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 2.90 | 3.20 | 0.114 | 0.126 |
| c | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 5.55 | 6.25 | 0.218 | 0.246 |
| E | 7.75 | 8.15 | 0.305 | 0.321 |
| E1 | 6.60 | 7.15 | 0.260 | 0.281 |
| E2 | 4.40 | 4.70 | 0.173 | 0.185 |
| L | 0.75 | 1.50 | 0.030 | 0.059 |

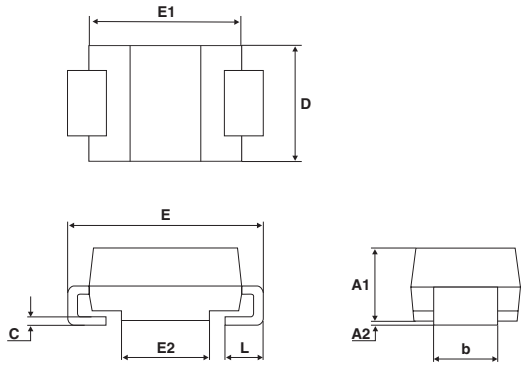
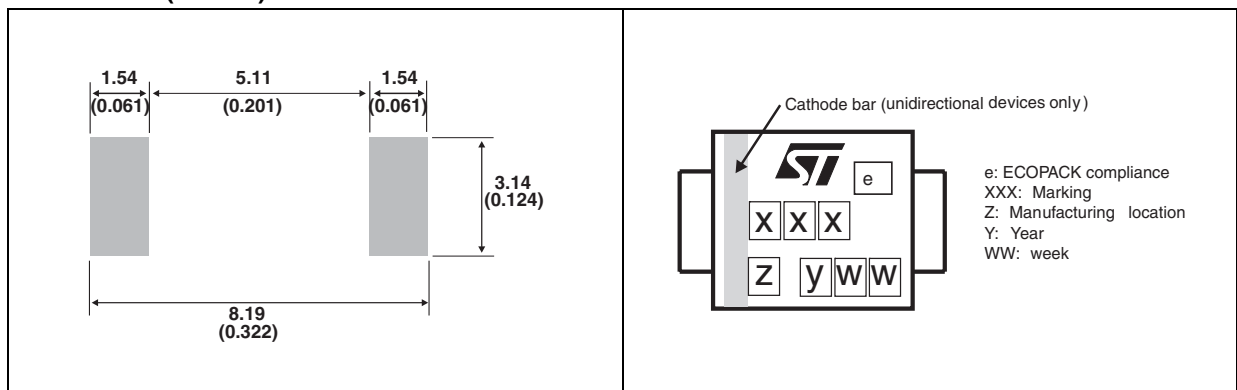


Figure 13. SMC footprint dimensions in mm (inches)

Figure 14. Marking layout⁽¹⁾



1. Marking layout can vary according to assembly location.

Table 5. Marking

| Order code | Marking | Order code | Marking |
|------------|---------|------------|---------|
| SM15T6V8A | MDE | SM15T6V8CA | BDE |
| SM15T7V5A | MDG | SM15T7V5CA | BDG |
| SM15T10A | MDP | SM15T10CA | BDP |
| SM15T12A | MDT | SM15T12CA | BDT |
| SM15T15A | MDX | SM15T15CA | BDX |
| SM15T18A | MEE | SM15T18CA | BEE |
| SM15T22A | MEK | SM15T22CA | BEK |
| SM15T24A | MEM | SM15T24CA | BEM |
| SM15T27A | MEP | SM15T27CA | BEP |
| SM15T30A | MER | SM15T30CA | BER |
| SM15T33A | MET | SM15T33CA | BET |
| SM15T36A | MEV | SM15T36CA | BEV |
| SM15T39A | MEX | SM15T39CA | BEX |
| SM15T68A | MFP | SM15T68CA | BFP |
| SM15T75A | MFO | SM15T75CA | BFO |
| SM15T100A | MFX | SM15T100CA | BFX |
| SM15T150A | MGK | SM15T150CA | BGK |
| SM15T200A | MGV | SM15T200CA | BGV |
| SM15T220A | MGX | SM15T220CA | BGX |

4 Ordering information

Table 6. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|-----------------------------|---------------------------------------|---------|--------|----------|---------------|
| SM15TxxxA/CA ⁽¹⁾ | See Table 5 on page 8 | SMC | 0.25 g | 2500 | Tape and reel |

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See [Table 3](#) for list of available devices and their order codes

5 Revision history

Table 7. Document revision history

| Date | Revision | Description of changes |
|----------------|----------|--|
| September-2001 | 3B | Last issue |
| 19-Feb-2007 | 4 | Peak pulse power Figure 4 on page 4 updated. |
| 04-Feb-2009 | 5 | Updated ECOPACK statement. Added R_D columns in Table 3 . Updated characteristic curves, Figure 3 to Figure 11 . |
| 17-Sep-2009 | 6 | Document updated for low leakage current. |

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